

SN54190, SN54191, SN54LS190, SN54LS191 SN74190, SN74191, SN74LS190, SN74LS191

Synchronous Up/Down Counters with Down/Up Mode Control

The '190, 'LS190, '191, and 'LS191 are synchronous, reversible up/down counters having a complexity of 58 equivalent gates. The '191 and 'LS191 are 4-bit binary counters and the '190 and 'LS190 are BCD counters. Synchronous operation is provided by having all flip-flops clocked simultaneously so that the outputs change coincident with each other when so instructed by the steering logic. This mode of operation eliminates the output counting spikes normally associated with asynchronous (ripple clock) counters.

Rochester Electronics Manufactured Components

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Parts are tested using original factory test programs or Rochester developed test solutions to guarantee product meets or exceeds the OCM data sheet.

Quality Overview

- ISO-9001
- AS9120 certification
- Qualified Manufacturers List (QML) MIL-PRF-38535
 - Class Q Military
 - Class V Space Level
- Qualified Suppliers List of Distributors (QSLD)
 - Rochester is a critical supplier to DLA and meets all industry and DLA standards.

Rochester Electronics, LLC is committed to supplying products that satisfy customer expectations for quality and are equal to those originally supplied by industry manufacturers.

The original manufacturer's datasheet accompanying this document reflects the performance and specifications of the Rochester manufactured version of this device. Rochester Electronics guarantees the performance of its semiconductor products to the original OEM specifications. 'Typical' values are for reference purposes only. Certain minimum or maximum ratings may be based on product characterization, design, simulation, or sample testing.

SN54190, SN54191, SN54LS190, SN54LS191, SN74190, SN74191, SN74LS190, SN74LS191 SYNCHRONOUS UP/DOWN COUNTERS WITH DOWN/UP MODE CONTROL

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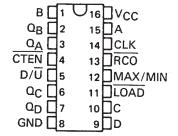
- Counts 8-4-2-1 BCD or Binary
- Single Down/Up Count Control Line
- Count Enable Control Input
- Ripple Clock Output for Cascading
- Asynchronously Presettable with Load Control
- Parallel Outputs
- Cascadable for n-Bit Applications

		TYPICAL	
	AVERAGE	MAXIMUM	TYPICAL
TYPE	PROPAGATION	CLOCK	POWER
	DELAY	FREQUENCY	DISSIPATION
190,191	20 ns	25MHz	325mW
'LS190,'LS191	20 ns	25MHz	100mW

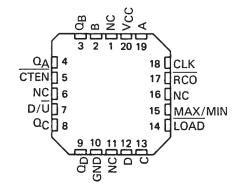
description

The '190, 'LS190, '191, and 'LS191 are synchronous, reversible up/down counters having a complexity of 58 equivalent gates. The '191 and 'LS191 are 4-bit binary counters and the '190 and 'LS190 are BCD counters. Synchronous operation is provided by having all flipflops clocked simultaneously so that the outputs change coincident with each other when so instructed by the steering logic. This mode of operation eliminates the output counting spikes normally associated with asynchronous (ripple clock) counters.

SN54190, SN54191, SN54LS190, SN54LS191 . . . J PACKAGE SN74190, SN74191 . . . N PACKAGE SN74LS190, SN74LS191 . . . D OR N PACKAGE (TOP VIEW)



SN54LS190, SN54LS191 . . . FK PACKAGE (TOP VIEW)



NC - No internal connection

The outputs of the four master-slave flip-flops are triggered on a low-to-high transition of the clock input if the enable input is low. A high at the enable input inhibits counting. Level changes at the enable input should be made only when the clock input is high. The direction of the count is determined by the level of the down/up input. When low, the counter count up and when high, it counts down. A false clock may occur if the down/up input changes while the clock is low. A false ripple carry may occur if both the clock and enable are low and the down/up input is high during a load pulse.

These counters are fully programmable; that is, the outputs may be preset to either level by placing a low on the load input and entering the desired data at the data inputs. The output will change to agree with the data inputs independently of the level of the clock input. This feature allows the counters to be used as modulo-N dividers by simply modifying the count length with the preset inputs.

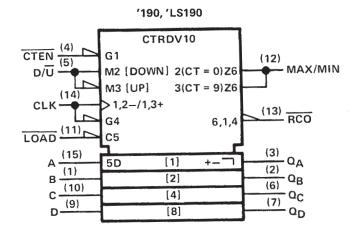
The clock, down/up, and load inputs are buffered to lower the drive requirement which significantly reduces the number of clock drivers, etc., required for long parallel words.

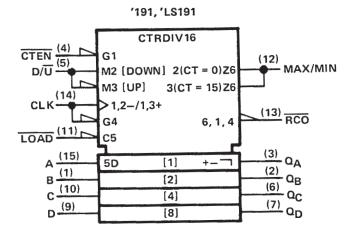
Two outputs have been made available to perform the cascading function: ripple clock and maximum/minimum count. The latter output produces a high-level output pulse with a duration approximately equal to one complete cycle of the clock when the counter overflows or underflows. The ripple clock output produces a low-level output pulse equal in width to the low-level portion of the clock input when an overflow or underflow condition exists. The counters can be easily cascaded by feeding the ripple clock output to the enable input of the succeeding counter if parallel clocking is used, or to the clock input if parallel enabling is used. The maximum/minimum count output can be used to accomplish look-ahead for high-speed operation.

Series 54' and 54LS' are characterized for operation over the full military temperature range of -55°C to 125°C; Series 74' and 74LS' are characterized for operation from 0°C to 70°C.

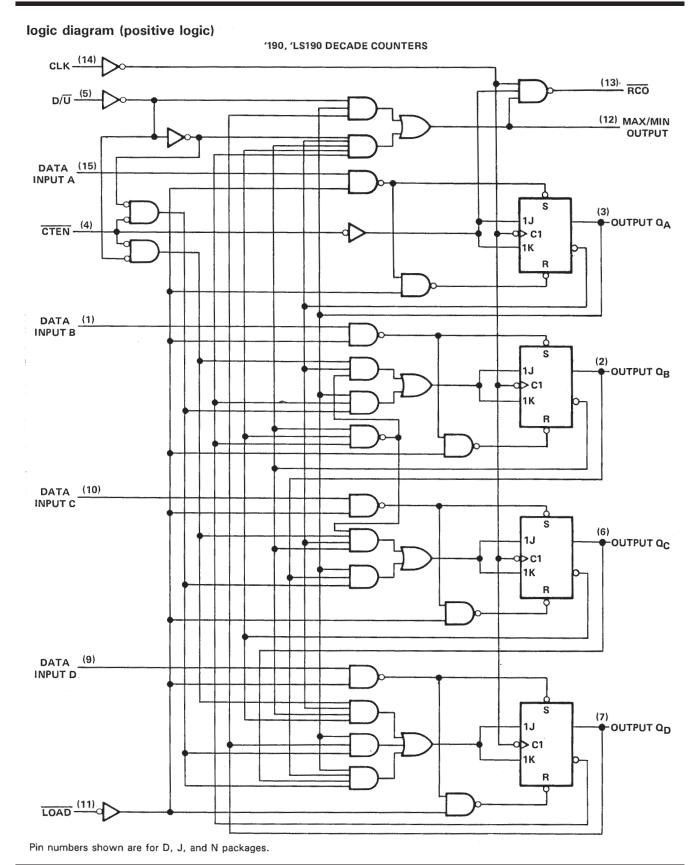


logic symbols†

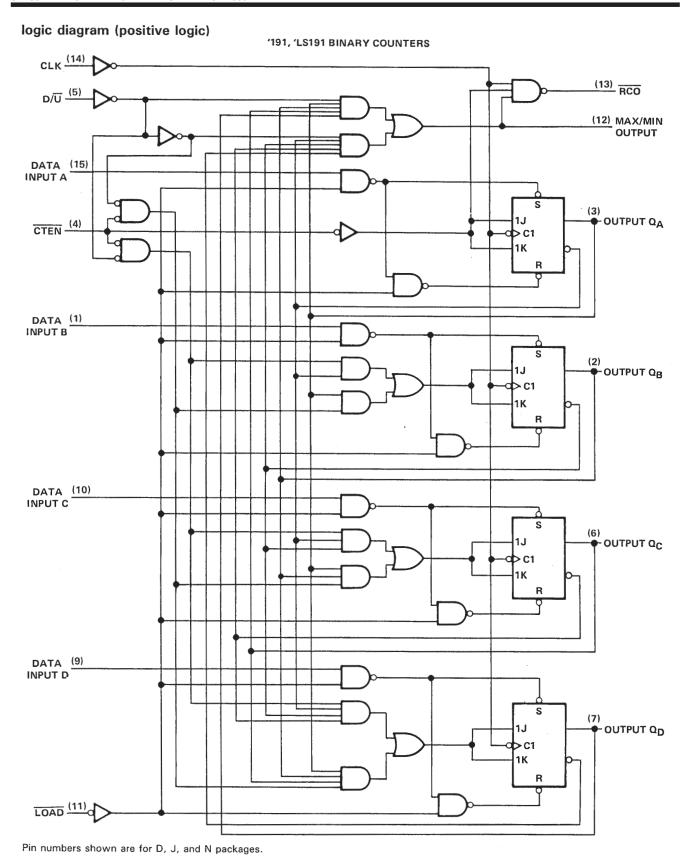




[†] These symbols are accordance with ANSI/IEEE Std 91-1984 and IEC Publication 617-12. Pin numbers shown are for D, J, and N packages.







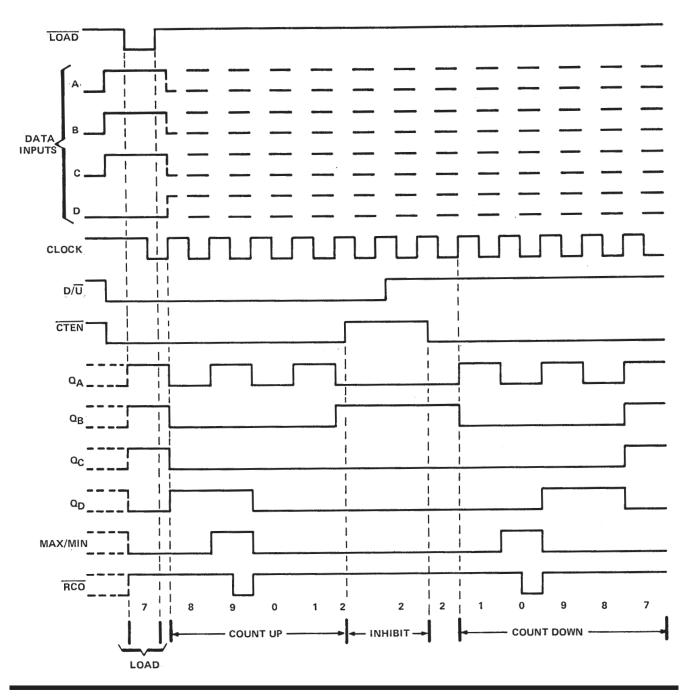


'190, 'LS190 DECADE COUNTERS

typical load, count, and inhibit sequences

Illustrated below is the following sequence:

- 1. Load (preset) to BCD seven.
- 2. Count up to eight, nine (maximum), zero, one, and two.
- 3. Inhibit.
- 4. Count down to one, zero (minimum), nine, eight, and seven.



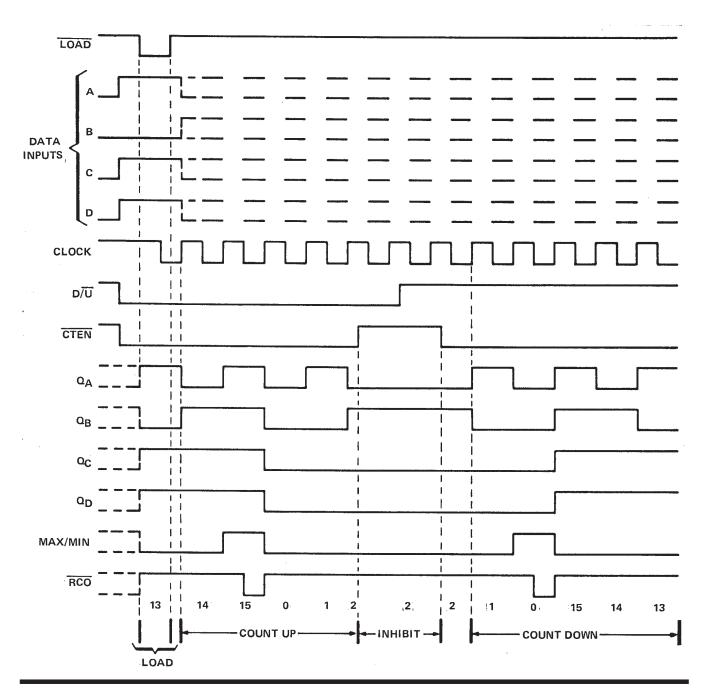


'191, 'LS191 BINARY COUNTERS

pical load, count, and inhibit sequences

Illustrated below is the following sequence:

- 1. Load (preset) to binary thirteen.
- 2. Count up to fourteen, fifteen (maximum), zero, one, and two.
- 3. Inhihit
- 4. Count down to one, zero (minimum), fifteen, fourteen, and thirteen.





SN54190, SN54191, SN54LS190, SN54LS191, SN74190, SN74191, SN74LS190, SN74LS191 SYNCHRONOUS UP/DOWN COUNTERS WITH DOWN/UP MODE CONTROL

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absolute maximum ratings over operating free-air temperature range (unless otherwise noted)

Supply voltage, VCC (see Note 1)
Input voltage: SN54', SN74' Circuits
SN54LS', SN74LS' Circuits
Operating free-air temperature range: SN54', SN54LS' Circuits
SN74', SN74LS' Circuits
Storage temperature range

NOTE 1: Voltage values are with respect to network ground terminal.

recommended operating conditions

			SN54	SN54190, SN54191		SN74	UNIT		
			MIN	NOM	MAX	MIN	NOM	5.25 0.8	DIVIT
Vcc	Supply voltage		4.5	5	5.5	4.75	5	5.25	V
ЮН	High-level output	ligh-level output current			0.8			- 0.8	mA
loL	Low-level output	current			16			16	mA
fclock	Input clock frequ	ency	0		20	0		20	MHz
tw(clock)	Width of clock in	put pulse	25			25			ns
tw(load)	Width of load inp	ut pulse	35			35			ns
	Setup time	Data, high or low (See Figure 1 and 2)	20			20			ns
t _{su}	Setup time	Load inactive state	20			20		MAX 5.25 - 0.8 16 20	113
thold	Data hold time		0			0			ns
TA	Operating free-air	temperature	- 55		125	0		70	°C

electrical characteristics over recommended operating free-air temperature range (unless otherwise noted)

PARAMETER		TEST CONDITIONS†	SN54	190, SN	54191	SN74				
	PARAMETER	TEST CONDITIONS.		TYP‡	MAX	MIN	TYP‡	MAX	UNIT	
V_{1H}	High-level input voltage	V _{CC} = MIN	2			2			V.	
٧١L	Low-level input voltage	V _{CC} = MIN			0.8			0.8	٧	
VIK	Input clamp voltage	V _{CC} = MIN, I ₁ = -12 mA			-1.5			-1.5	٧	
V _{OH}	High-level output voltage	V _{CC} = MIN, V _{IH} = 2 V, V _{IL} = 0.8 V, I _{OH} = -0.8 mA	2.4	3.4		2.4	3.4		V	
VOL	Low-level output voltage	V _{CC} = MIN, V _{IH} = 2 V, V _{IL} = 0.8 V, I _{OL} = 16 mA		0.2	0.4		0.2	0.4	V	
l ₁	High-level input current at maximum input voltage	V _{CC} = MAX, V _I = 5.5 V			1			1	mA	
ΊΗ	High-level input current at any input except enable			-	40			40	μА	
ΉΗ	High-level input current at enable input	V _{CC} = MAX, V _I = 2.4 V			120			120	μΑ	
IIL	Low-level input current at any input except enable	V MAY V 0.4 V			-1.6			-1.6	mA	
Low-level input current at enable input		V _{CC} = MAX, V _I = 0.4 V			-4.8			-4.8	mA	
los	Short-circuit output current§	V _{CC} = MAX	-20		-65	-18		-65	mA	
ICC	Supply current	V _{CC} = MAX, See Note 2		65	99		65	105	mA	

[†] For conditions shown as MAX or MIN, use appropriate value specified under recommended operating conditions.

NOTE 2: I_{CC} is measured with all inputs grounded and all outputs open.



 $[\]ddagger$ All typical values are at $V_{CC} = 5 \text{ V}, T_A = 25^{\circ}\text{C}.$

 $[\]S$ Not more than one output should be shorted at a time.

SN54190, SN54191, SN74190, SN74191 SYNCHRONOUS UP/DOWN COUNTERS WITH DOWN/UP MODE CONTROL

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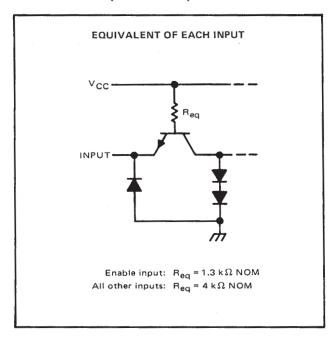
switching characteristics, $V_{CC} = 5 \text{ V}$, $T_A = 25^{\circ}\text{C}$

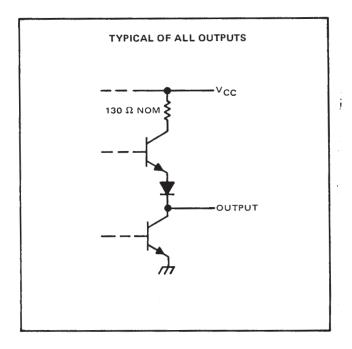
D.D	FROM	FROM TO			J			
PARAMETER†	TEST CONDITIONS (INPUT) (OUTPUT)	TEST CONDITIONS	MIN	TYP	MAX	UNIT		
f _{max}			•	20	25		MHz	
[†] PLH	Load	Q_A, Q_B, Q_C, Q_D	1		22	33	ns	
^t PHL	Load	ay, aB, ac, ap			33	50	113	
^t PLH	Data A, B, C, D	Q_A, Q_B, Q_C, Q_D	1		14	22	22 ns	
^t PHL	Data A, B, C, B	ay, ag, ac, ap			35	50	113	
^t PLH	CLK	RCO	$C_{L} = 15 pF, R_{L} = 400 \Omega,$		13	20	ns	
^t PHL] OLK	CLK QA, QB, QC, QD			16	24	7 115	
^t PLH	CIK			16 24	24	ns		
t _{PHL}					24	36	115	
^t PLH	- CLK	Max/Min	1		28	42		
^t PHL	CLK	IVIax/IVIIn			37	52	ns	
^t PLH	D/Ū	RCO			30	45	ns	
^t PHL] 5/6	HCU			30	45] ns	
^t PLH	D/Ū	Max/Min	7		21	33		
^t PHL] 5/6	WidX/WiTI			22	33	ns	

 † f_{max} = maximum clock frequency tpLH = propagation delay time, low-to-high-level output

tpHL ≡ propagation delay time, high-to-low-level output

schematics of inputs and outputs





recommended operating conditions

			SN	154LS1	90	S	N74LS1	90	
			SI	154LS1	91	S	N74LS1	91	UNIT
		. М	IIN	NOM	MAX	MIN	NOM	MAX	
Vcc	Supply voltage	4	4.5	5	5.5	4.75	5	5.25	V
ЮН	High-level output current				- 0.4			- 0.4	mA
lOL	Low-level output current				4			8	mA
fclock	Clock frequency		0		20	0		20	MHz
tw(clock)	Width of clock input pulse		25			25			ns
tw(load)	Width of load input pulse		35			35			ns
t _{su}	Data setup time (See Figures 1 and 2)		20			20			ns
t _{su}	Load inactive state setup time		30			30			ns
th	Data hold time		5			5			ns
th	Enable hold time		0	,		0			ns
^t enable	Count enable time (see Note 3)	-	40			40			ns
TA	Operating free-air temperature	-	- 55		125	0		70	°C

electrical characteristics over recommended operating free-air temperature range (unless otherwise noted)

PARAMETER		TEST CONDITIONS [†]		SN54LS190 SN54LS191			SN74LS190 SN74LS191			UNIT		
						TYP‡	MAX	MIN	TYP‡	MAX		
VIH	High-level input voltag	e				2			2			٧
VIL	Low-level input voltag	е						0.7			0.8	٧
٧ _{IK}	Input clamp voltage		V _{CC} = MIN,	I ₁ = -18 mA				-1.5			-1.5	٧
v _{oH}	High-level output volta	age	V _{CC} = MIN, V _{IL} = V _{IL} max,	V _{IH} = 2 V, I _{OH} = -400 μA		2.5	3.4		2.7	3.4		٧
VOL	Low-level output volta	ige	V _{CC} = MIN, V _{IL} = V _{IL} max	V _{1H} = 2 V,	I _{OL} = 4 mA		0.25	0.4		0.25 0.35	0.4	1 V 1
ij	High-level input	Enable	Vcc = MAX,					0.3			0.3	
''	input voltage	Others	VCC - WAX,	V ₁ = 7 V				0.1			0.1	mA
,	High-level	Enable		CC = MAX, V _I = 2.7 V				60			60	
ин	input current	Others	VCC = MAX,					20			20	μΑ
Lu	Low-level Enable		V. = 0.4.V	V - 0 4 V			-1.2			-1.2	A	
11L	input current	Others	V _{CC} = MAX,	V _I = 0.4 V				-0.4			-0.4	mA
los	Short-circuit output c	urrent§	V _{CC} = MAX,			-20		-100	-20		-100	mA
1cc	Supply current		V _{CC} = MAX,	See Note 2			20	35		20	35	mA

[†] For conditions shown as MAX or MIN, use appropriate value specified under recommended operating conditions for the applicable device type.



 $[\]ddagger$ AII typical values are at $V_{CC} = 5 \text{ V}$, $T_A = 25^{\circ} \text{C}$.

[§]Not more than one output should be shorted at a time, and duration of the short-circuit should not exceed one second.

NOTES: 2. ICC is measured with all inputs grounded and all outputs open.

Minimum count enable time is the interval immediately preceding the rising edge of the clock pulse during which interval the count enable input must be low to ensure counting.

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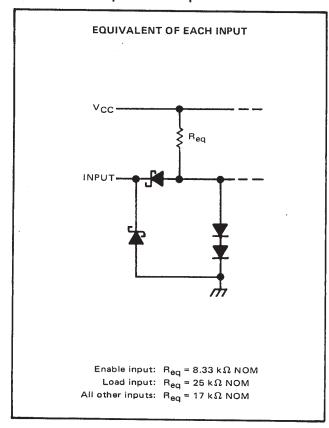
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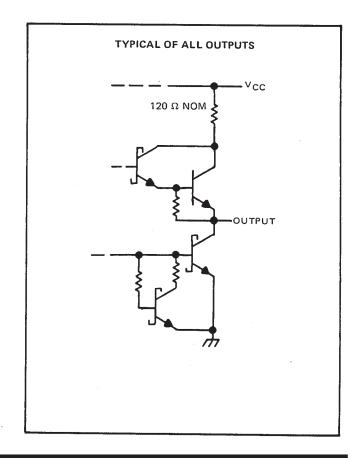
switching characteristics, $V_{CC} = 5 \text{ V}$, $T_A = 25^{\circ}\text{C}$

PARAMETER†	FROM	TEST CONDITIONS		'LS	190, 'L	S191	I
PARAIVIE I ER	(INPUT)	(OUTPUT)	TEST CONDITIONS		TYP	MAX	UNIT
f _{max}				20	25		MHz
tPLH.	Load	0. 0- 0- 0-			22	33	
tPHL	Load	$\Omega_A, \Omega_B, \Omega_C, \Omega_D$			33	50	ns
^t PLH	Data A, B, C, D	Q_A, Q_B, Q_C, Q_D	7		20	32	1
^t PHL	Data A, B, C, D	αΔ, αΒ, αC, αD			27	40	ns
^t PLH	CLK \overline{RCO} $C_L = 15 \text{ pF}, R_L = 2 \text{ k}\Omega,$ See Figures 1 and 3 thru 7		13	20			
^t PHL		RCO			16	24	ns
^t PLH		Q _A , Q _B , Q _C , Q _D			16	24	
^t PHL	CLK				24	36	ns
tPLH	OLK.				28	42	
^t PHL	CLK	IVIAX/IVIII)			37	52	ns
^t PLH	5/5		1		30	45	
^t PHL	D/Ū	RCO			30	45	ns
^t PLH		Max/Min	7		21	33	
^t PHL		IVIdX/IVIII)			22	33	ns
tpLH_					21	33	
[†] PHL	CTEN	RCO			22	33	ns

† f_{max} ≡ maximum clock frequency tp_{LH} ≡ propagation delay time, low-to-high-level output tp_{HL} ≡ propagation delay time, high-to-low-level output

schematics of inputs and outputs





PARAMETER MEASUREMENT INFORMATION

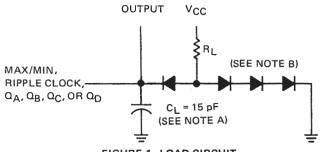
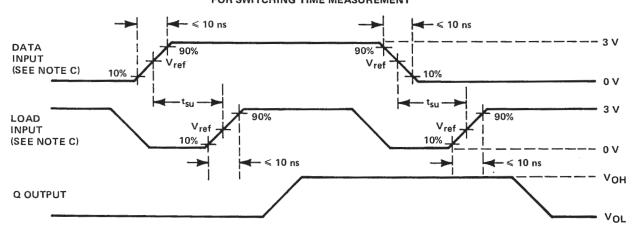
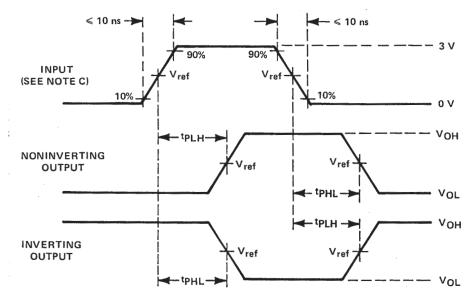


FIGURE 1-LOAD CIRCUIT FOR SWITCHING TIME MEASUREMENT



FIGUTE 2-DATA SETUP TIME VOLTAGE WAVEFORMS



See waveform sequences in figures 4 through 7 for propagation times from a specific input to a specific output. For simplication, pulse rise times, reference levels, etc., have not been shown in figures 4 through 7.

FIGURE 3-GENERAL VOLTAGE WAVEFORMS FOR PROPAGATION TIMES

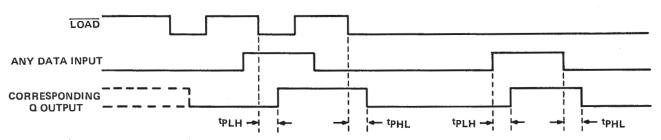
NOTES: A. C_L includes probe and jig capacitance.

- B. All diodes are 1N3064 or equivalent.
- C. The input pulses are supplied by generators having the following characteristics: $Z_{out} = 50 \Omega$, duty cycle $\leq 50\%$, PRR ≤ 1 MHz.
- D. $V_{ref} = 1.5 \text{ V for '190 and '191; 1.3 V for 'LS190 and 'LS191.}$



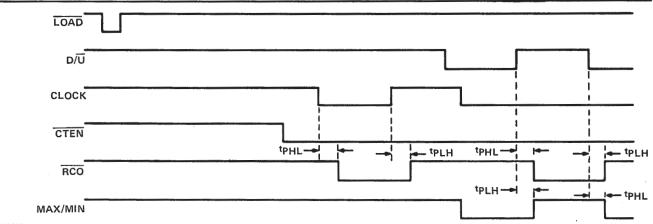
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NOTE E: Conditions on other inputs are irrelevant.

FIGURE 4-LOAD TO OUTPUT AND DATA TO OUTPUT

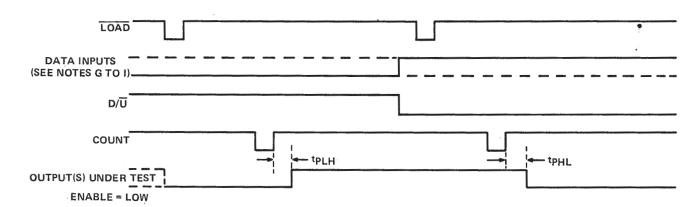


NOTE F: All data inputs are low.

FIGURE 5-ENABLE TO RIPPLE CLOCK, CLOCK TO RIPPLE CLOCK, DOWN/UP TO RIPPLE CLOCK, AND DOWN/UP TO MAX/MIN

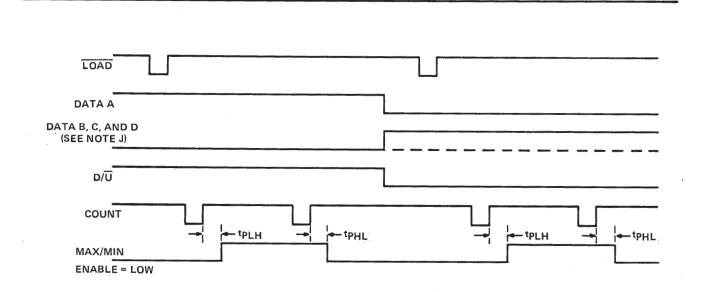
PARAMETER MEASUREMENT INFORMATION (continued)

switching characteristics (continued)



- NOTES: G. To test Q_A , Q_B , and Q_C outputs of '190 and 'LS190: Data inputs A, B, and C are shown by the solid line. Data input D is shown by the dashed line.
 - H. To test Q_D output of '190 and 'LS190: Data inputs A and D are shown by the solid line. Data inputs B and C are held at the low logic level.
 - I. To test Q_A , Q_B , Q_C , and Q_D outputs of '191 and 'LS191: All four data inputs are shown by the solid line.

FIGURE 6-CLOCK TO OUTPUT



NOTE J: Data inputs B and C are shown by the dashed line for the '190 and 'LS190 and the solid line for the '191 and 'LS191: Data input D is shown by the solid line for both devices.

FIGURE 7-CLOCK TO MAX/MIN



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